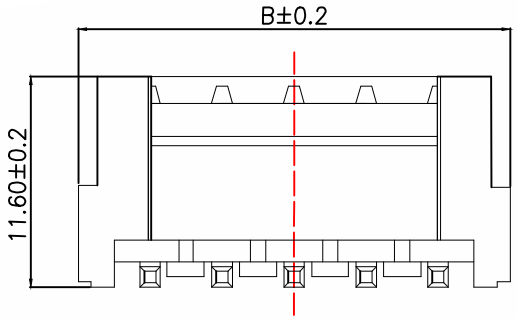
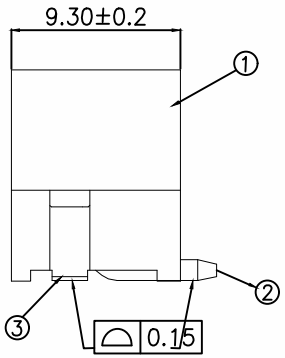
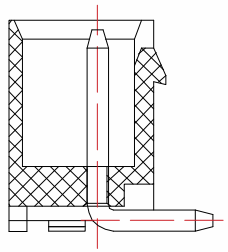
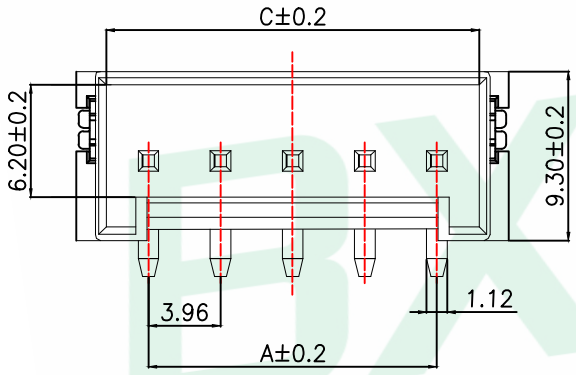
REV.	DESCRIPTION	ECN NO.	NAME	DATE

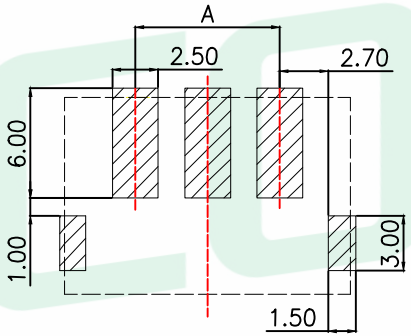




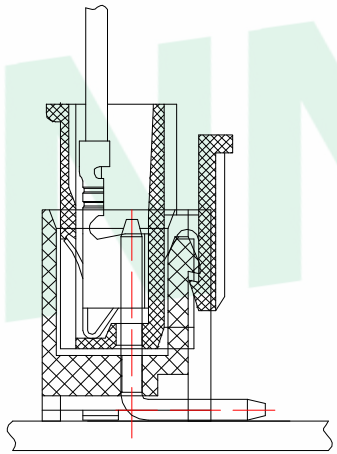

SECTION A–A

序号	名称	材料	数量	备注
3	焊片 Fitting Nail	黄铜	2	电镀(锡):整个表面镀底镍30u"MIN,再镀锡80u"MIN
2	端子 Contact	黄铜	N*1	电镀(锡):整个表面镀底镍30u"MIN,再镀锡80u"MIN
1	基座 Wafer	LCP (UL94V-0)	1	米色





SUGGESTED PCB LAYOUT
(COMPONENT SIDE)


SUGGESTED PCB LAYOUT
(COMPONENT SIDE)

技术要求:

1.塑件材料:LCP(UL-94V-0)
2.接触件:黄铜镀锡
3.接触电阻:≤30mΩ
4.绝缘电阻:≥1000MΩ
5.额定电压:250V AC DC
6.额定电流:7.0A AC DC
7.耐压:能承受1000V AC/Minute
8.工作温度:-25°~+85°
9.可焊性试验:
浸锡面积≥95%温度260,时间2.5±0.5秒
10.铅和镉等六大有害物质含量要符合环保要求.

Part No	Pin	A	B	C
WF-1E396A2P	2	3.96	11.88	8.60
WF-1E396A3P	3	7.92	15.84	12.56
WF-1E396A4P	4	11.88	19.80	16.52
WF-1E396A5P	5	15.84	23.76	20.48
WF-1E396A6P	6	19.80	27.72	24.44
WF-1E396A7P	7	23.76	31.68	28.40
WF-1E396A8P	8	27.72	35.64	32.36
WF-1E396A9P	9	31.68	39.60	36.32
WF-1E396A10P	10	35.64	43.56	40.28

GENERAL TOLERANCE

DIM.	TOL.
.x	±0.25
.xx	±0.12
.xxx	±0.05

GENERAL ANGLE: ±3°

DONGGUAN BAOXUN PRECISION TECHNOLOGY CO., LTD

BXCONN®

TITLE: WAFER VH3.96 立贴

DWG. NO.: WF-1E396AXP

CHECKED: MAX

PART NO.: WF-1E396AXP

DRAWN: ELLA

UNIT:	SCALE:	SHEET:	DWG. SIZE:	LAYER:	APPROVED:
mm	none	1of 1	A4	bxconn	WILL

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